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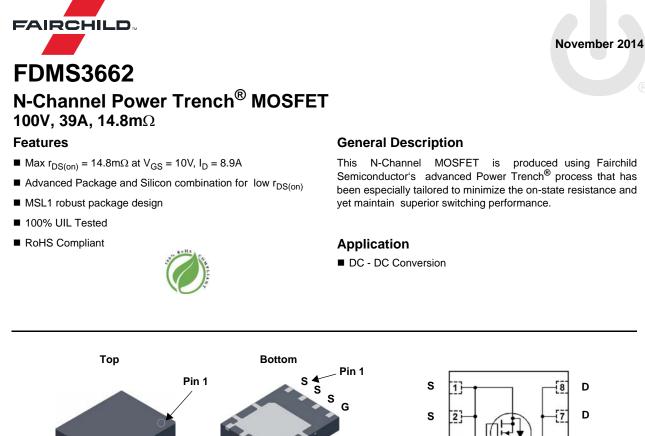


## **ON Semiconductor**®

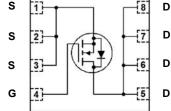
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Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (\_), the underscore (\_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (\_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at <a href="mailto:www.onsemi.com">www.onsemi.com</a>. Please email any questions regarding the system integration to <a href="mailto:Fairchild\_questions@onsemi.com">Fairchild\_questions@onsemi.com</a>.

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Power 56



FDMS3662 N-Channel Power Trench<sup>®</sup> MOSFET

#### MOSFET Maximum Ratings T<sub>A</sub> = 25°C unless otherwise noted

D D D

Symbol	Parameter			Ratings	Units	
V <sub>DS</sub>	Drain to Source Voltage			100	V	
V <sub>GS</sub>	Gate to Source Voltage			±20	V	
I <sub>D</sub>	Drain Current -Continuous	T <sub>C</sub> = 25°C		39		
	-Continuous	$T_A = 25^{\circ}C$	(Note 1a)	8.9	A	
	-Pulsed			90		
E <sub>AS</sub>	Single Pulse Avalanche Energy		(Note 3)	384	mJ	
P <sub>D</sub>	Power Dissipation	T <sub>C</sub> = 25°C		104	W	
	Power Dissipation	$T_A = 25^{\circ}C$	(Note 1a)	2.5	VV	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range			-55 to +150	°C	

#### **Thermal Characteristics**

$R_{\thetaJC}$	Thermal Resistance, Junction to Case	1.2	°C/W
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient (Note 1a)	50	C/vv

#### Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS3662	FDMS3662	Power 56	13"	12mm	3000 units

FDMS3662
N-Channel F
ower
Trench®
MOSFET

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Off Chara <sup>BV<sub>DSS</sub> ∆BV<sub>DSS</sub></sup>	cteristics						
	Drain to Source Breakdown Voltage	$I_{D} = 250 \mu A, V_{GS} = 0 V$	100			V	
	Breakdown Voltage Temperature			74			
$\Delta T_{J}$	Coefficient	$I_D = 250\mu A$ , referenced to 25°C		74		mV/°C	
DSS	Zero Gate Voltage Drain Current	$V_{GS} = 0V, V_{DS} = 80V,$			1	μA	
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = \pm 20V, V_{DS} = 0V$			±100	nA	
On Chara	cteristics						
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \mu A$	2.5	3.5	4.5	V	
$\Delta V_{GS(th)}$	Gate to Source Threshold Voltage	$I_{\rm D} = 250 \mu \text{A}$ , referenced to 25°C		-10.8		mV/°(	
$\Delta T_{J}$	Temperature Coefficient				44.0		
r <sub>DS(on)</sub>	Static Drain to Source On Resistance	$V_{GS} = 10V, I_D = 8.9A$		11.4	14.8	mΩ	
	Forward Transconductors	$V_{GS} = 10V, I_D = 8.9A, T_J = 125^{\circ}C$		19.0	24.7	<u> </u>	
9fs	Forward Transconductance	$V_{DD} = 10V, I_D = 8.9A$		37		S	
Dynamic (	Characteristics						
C <sub>iss</sub>	Input Capacitance			3470	4620	pF	
C <sub>oss</sub>	Output Capacitance	$V_{DS} = 50V, V_{GS} = 0V,$ f = 1MHz		245	325	pF	
C <sub>rss</sub>	Reverse Transfer Capacitance			110	165	pF	
R <sub>g</sub>	Gate Resistance	f = 1MHz		1.4		Ω	
Switching	Characteristics						
t <sub>d(on)</sub>	Turn-On Delay Time			25	40	ns	
r	Rise Time	V <sub>DD</sub> = 50V, I <sub>D</sub> = 8.9A,		15	26	ns	
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS} = 10V, R_{GEN} = 6\Omega$		32	52	ns	
t <sub>f</sub>	Fall Time	GG / GEN		6	10	ns	
Q <sub>g</sub>	Total Gate Charge at 10V			54	75	nC	
∽g Q <sub>gs</sub>	Gate to Source Charge	$V_{DD} = 50V,$		18		nC	
Q <sub>gd</sub>	Gate to Drain "Miller" Charge	I <sub>D</sub> = 8.9A		15		nC	
	Irce Diode Characteristics						
		V <sub>GS</sub> = 0V, I <sub>S</sub> = 8.9A (Note 2)		0.8	1.3	V	
V <sub>SD</sub>	Source to Drain Diode Forward Voltage	$V_{GS} = 0V, I_S = 0.0A$ (Note 2) $V_{GS} = 0V, I_S = 2.1A$ (Note 2)		0.0	1.2	v	
t <sub>rr</sub>	Reverse Recovery Time			45	73	ns	
Q <sub>rr</sub>	Reverse Recovery Charge	— I <sub>F</sub> = 8.9A, di/dt = 100A/μs		71	115	nC	

**Test Conditions** 

Min

Тур

Max

Units

Electrical Characteristics T<sub>J</sub> = 25°C unless otherwise noted

Parameter

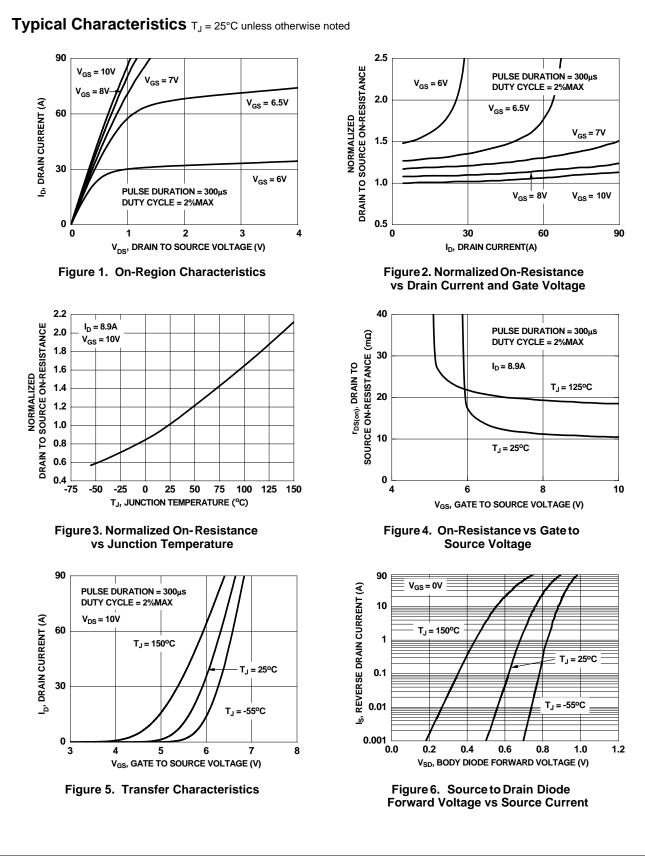
Symbol

2. Pulse Test: Pulse Width < 300 $\mu$ s, Duty cycle < 2.0%.

3. Starting  $T_J$  = 25°C, L = 3mH,  $I_{AS}$  = 16A,  $V_{DD}$  = 100V,  $V_{GS}$  = 10V

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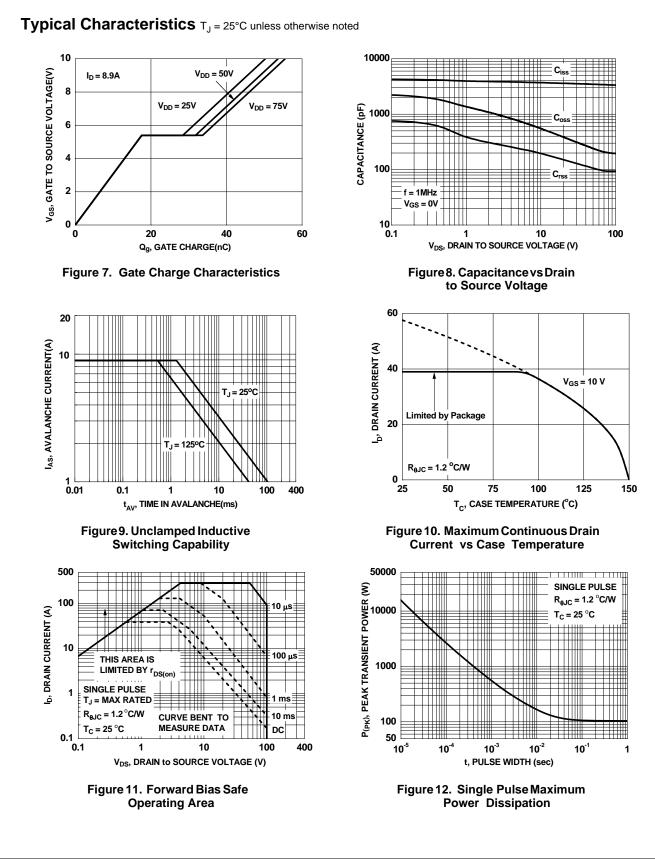
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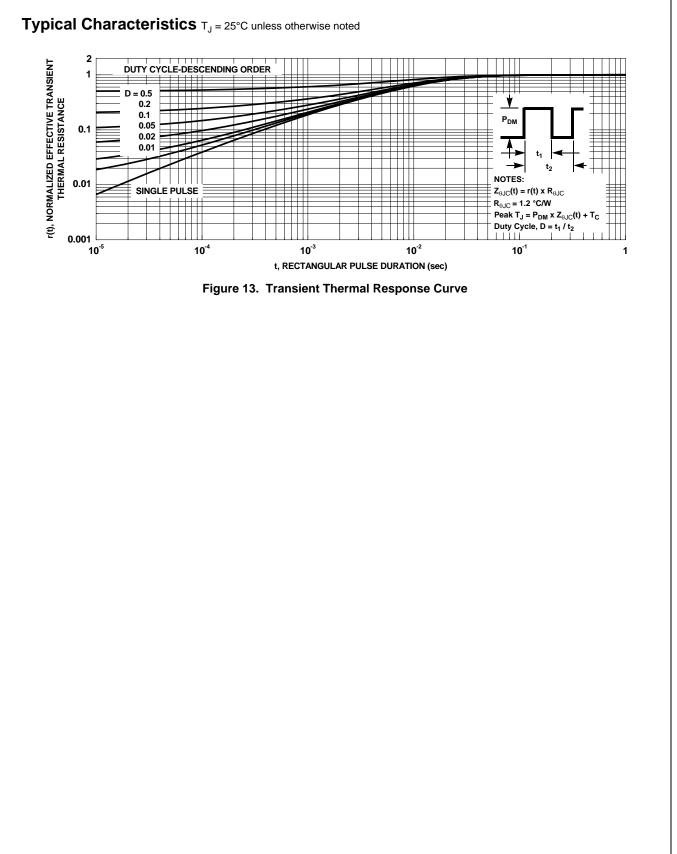




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